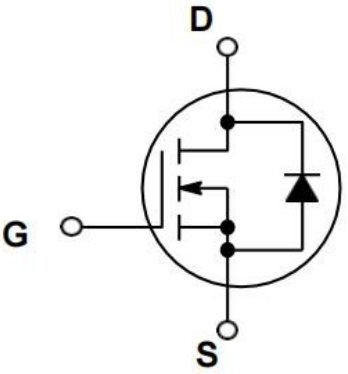
# Silicon Carbide (SiC), 25 mohm, 1200 V, TO-247-3L QX3L025N120

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | $I_D$ |
|---|---|---|
| 1200 V | 25 mΩ | 75 A |

N−CHANNEL MOSFET

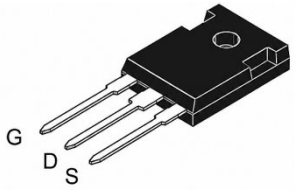



### Features

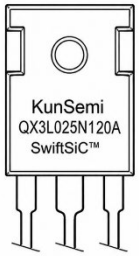
- Typ. $R_{DS(on)}$ = 25 mΩ @ $V_{GS}$ = 18 V
- Ultra Low Gate Charge ($Q_{G(tot)}$ = 98.6 nC)
- High Speed Switching with Low Capacitance
- 100% Avalanche Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb−Free 2LI (on second level interconnection)

### Typical Applications

- Solar Inverters
- Electric Vehicle Charging Stations
- UPS (Uninterruptible Power Supplies)
- Energy Storage Systems
- SMPS (Switch Mode Power Supplies)




TO-247-3L




### MAXIMUM RATINGS ($T_J$ = 25°C unless otherwise noted)

| Parameter | | | Symbol | Value | Unit |
|---|---|---|---|---|---|
| Drain−to−Source Voltage | | | $V_{DSS}$ | 1200 | V |
| Gate−to−Source Voltage | | | $V_{GS}$ | −10/+25 | V |
| Recommended Operation Values of Gate−to−Source Voltage | | $T_C$<175°C | $V_{GSop}$ | −5/+20 | V |
| Continuous Drain Current (Notes 1, 3) | Steady State | $T_C$=25°C | $I_D$ | 75 | A |
| Power Dissipation (Note 1) | Steady State | $T_C$=25°C | $P_D$ | 431 | W |
| Continuous Drain Current (Notes 1, 3) | Steady State | $T_C$=100°C | $I_D$ | 66.3 | A |
| Power Dissipation (Note 1) | Steady State | $T_C$=100°C | $P_D$ | 260 | W |
| Pulsed Drain Current (Note 2) | $T_C$ = 25°C | | $I_{DM}$ | 160 | A |
| Operating Junction and Storage Temperature Range | | | $T_J$, $T_{stg}$ | −55 to +175 | °C |
| Source Current (Body Diode) $T_C$ = 25°C, $V_{GS}$ = −3 V | | | $I_S$ | 75 | A |
| Single Pulse Drain−to−Source Avalanche Energy (Note 4) | | | $E_{AS}$ | 1613 | mJ |
| Maximum Lead Temperature for Soldering (1/25″ from case for 10 s) | | | $T_L$ | 270 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
2. Repetitive rating, limited by max junction temperature.
3. The maximum current rating is based on typical $R_{DS(on)}$ performance.
4. EAS of 1613 mJ is based on starting $T_J$ = 25°C; L = 1 mH, $I_{AS}$ = 55 A, $V_{DD}$ = 100 V, $V_{GS}$ = 18 V.

### ORDERING INFORMATION

| Device | Package | Shipping |
|---|---|---|
| QX3L025N120 | TO−247−3L | 30 Units / Tube |

## TYPICAL CHARACTERISTICS

**Table 1. THERMAL CHARACTERISTICS**

| Parameter | Symbol | Max | Unit |
|---|---|---|---|
| Junction−to−Case − Steady State (Note 1) | $R_{\theta JC}$ | 0.29 | °C/W |
| Junction−to−Ambient − Steady State (Note 1) | $R_{\theta JA}$ | 40 | |

**Table 2. ELECTRICAL CHARACTERISTICS** ($T_J$ = 25°C unless otherwise specified)

| Parameter | Symbol | Test Condition | | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|---|
| **OFF−STATE CHARACTERISTICS** | | | | | | | |
| Drain−to−Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}$ = 0 V, $I_D$ = 1 mA | | 1200 | − | − | V |
| Drain−to−Source Breakdown Voltage Temperature Coefficient | $V_{(BR)DSS}/T_J$ | $I_D$ = 1 mA, referenced to 25°C (Note 6) | | − | 0.35 | − | V/°C |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 1200 V | $T_J$ = 25°C | − | − | 100 | μA |
| Gate−to−Source Leakage Current | $I_{GSS}$ | $V_{GS}$ = +3/−10 V, $V_{DS}$ = 0 V | | − | − | ±1 | μA |
| **ON−STATE CHARACTERISTICS** (Note 2) | | | | | | | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{GS}$ = $V_{DS}$, $I_D$ = 15 mA | | 1.5 | 2.2 | 3.1 | V |
| Recommended Gate Voltage | $V_{GOP}$ | | | −5 | − | +20 | V |
| Drain−to−Source On Resistance | $R_{DS(on)}$ | $V_{GS}$ = 18 V, $I_D$ = 30 A, $T_J$ = 25°C | | − | 25 | − | mΩ |
| | | $V_{GS}$ = 18 V, $I_D$ = 30 A, $T_J$ = 175°C (Note 6) | | − | 56 | − | |
| Forward Transconductance | $g_{FS}$ | $V_{DS}$ = 10 V, $I_D$ = 30 A (Note 6) | | − | 14 | − | S |
| **CHARGES, CAPACITANCES & GATE RESISTANCE** | | | | | | | |
| Input Capacitance | $C_{ISS}$ | $V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 800 V | | − | 2180 | − | pF |
| Output Capacitance | $C_{OSS}$ | | | − | 159 | − | |
| Reverse Transfer Capacitance | $C_{RSS}$ | | | − | 9.23 | − | |
| Total Gate Charge | $Q_{G(TOT)}$ | $V_{GS}$ = −3/18 V, $V_{DS}$ = 800 V, $I_D$ = 30 A | | − | 98.6 | − | nC |
| Threshold Gate Charge | $Q_{G(TH)}$ | | | − | 7.0 | − | |
| Gate−to−Source Charge | $Q_{GS}$ | | | − | 21.2 | − | |
| Gate−to−Drain Charge | $Q_{GD}$ | | | − | 26 | − | |
| Gate−Resistance | $R_G$ | f = 1 MHz | | − | 1.37 | − | Ω |
| **SWITCHING CHARACTERISTICS** | | | | | | | |
| Turn−On Delay Time | $t_{d(ON)}$ | $V_{GS}$ = −3/18 V, $V_{DS}$ = 800 V, $I_D$ = 15 A, $R_G$ = 4.7 Ω Inductive load (Notes 5, 6) | | − | 16.8 | − | ns |
| Rise Time | $t_r$ | | | − | 18.0 | − | |
| Turn−Off Delay Time | $t_{d(OFF)}$ | | | − | 32.0 | − | |
| Fall Time | $t_f$ | | | − | 11.0 | − | |
| Turn−On Switching Loss | $E_{ON}$ | | | − | 230.3 | − | μJ |
| Turn−Off Switching Loss | $E_{OFF}$ | | | − | 68.9 | − | |
| Total Switching Loss | $E_{tot}$ | | | − | 299.2 | − | |
| **SOURCE−DRAIN DIODE CHARACTERISTICS** | | | | | | | |
| Continuous Source−Drain Diode Forward Current | $I_{SD}$ | $V_{GS}$ = −3 V, $T_C$ = 25°C (Note 6) | | − | − | 75 | A |
| Pulsed Source−Drain Diode Forward Current (Note 2) | $I_{SDM}$ | | | − | − | 160 | |
| Forward Diode Voltage | $V_{SD}$ | $V_{GS}$ = −3 V, $I_{SD}$ = 30 A, $T_J$ = 25°C | | − | 4.0 | − | V |

**Table 2. ELECTRICAL CHARACTERISTICS** ($T_J$ = 25°C unless otherwise specified) (continued)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **SOURCE−DRAIN DIODE CHARACTERISTICS** | | | | | | |
| Reverse Recovery Time | $t_{RR}$ | $V_{GS}$ = −3/18 V, $I_{SD}$ = 30 A, $dI_S/dt$ = 1000 A/μs, $V_{DS}$ = 800V (Note 6) | − | 23.59 | − | ns |
| Reverse Recovery Charge | $Q_{RR}$ | | − | 144.15 | − | nC |
| Reverse Recovery Energy | $E_{REC}$ | | − | 13.83 | − | μJ |
| Peak Reverse Recovery Current | $I_{RRM}$ | | − | 12.22 | − | A |
| Charge Time | $T_A$ | | − | 13.47 | − | ns |
| Discharge Time | $T_B$ | | − | 10.12 | − | ns |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. $E_{ON}/E_{OFF}$ result is with body diode.
6. Defined by design, not subject to production test.

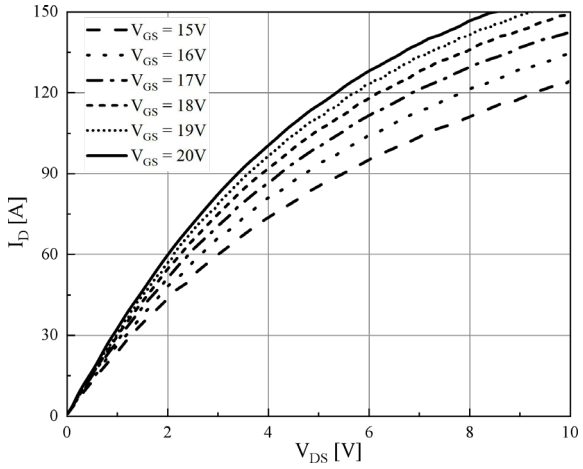



**Figure 1. On−Region Characteristics**

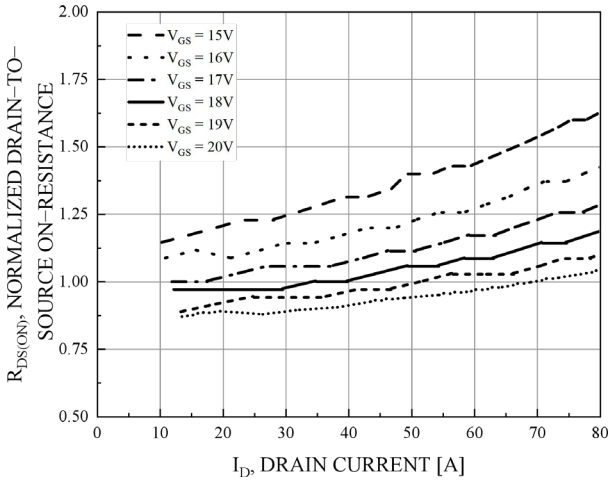



**Figure 2. Normalized On−Resistance vs. Drain Current and Gate Voltage**

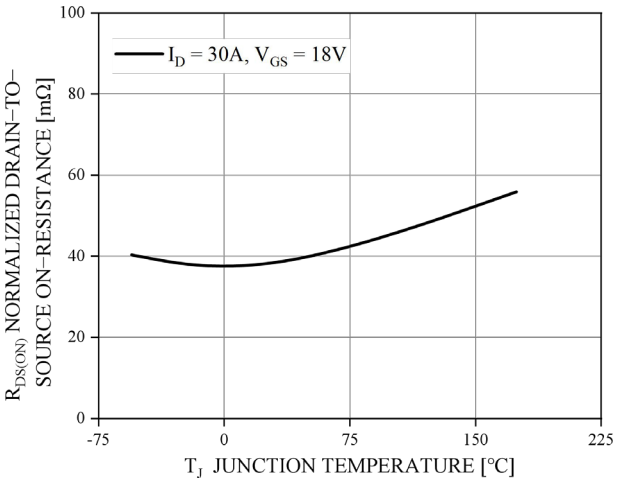



**Figure 3. On−Resistance Variation with Temperature**

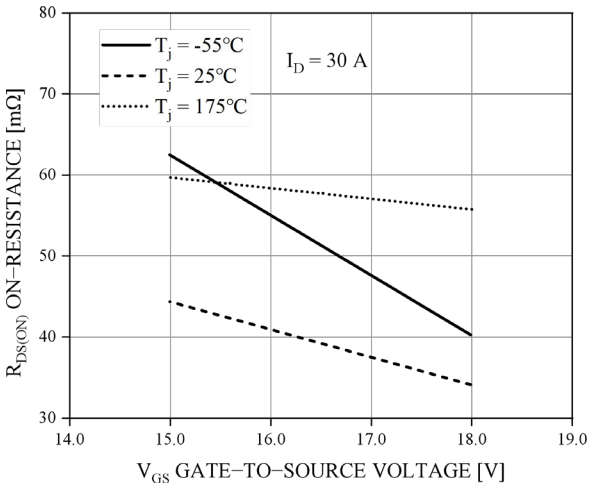



**Figure 4. On−Resistance vs. Gate−to−Source Voltage**

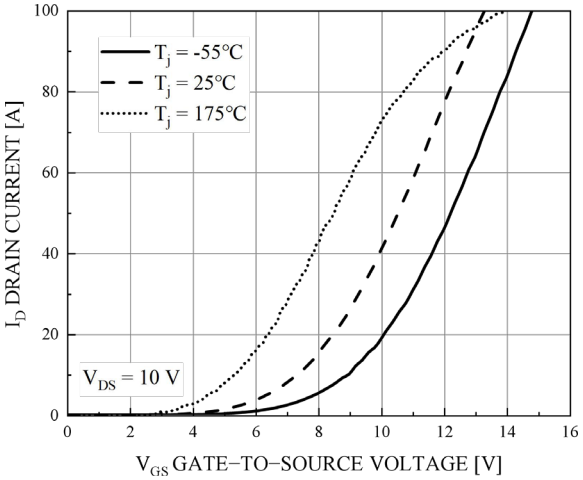



**Figure 5. Transfer Characteristics**

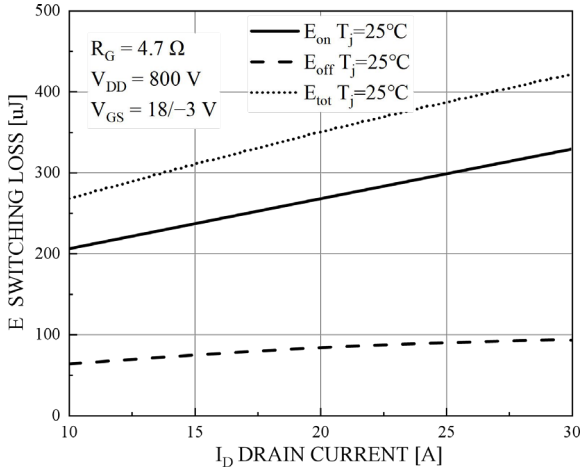



**Figure 6. Switching Loss vs. Drain Current**

## TYPICAL CHARACTERISTICS

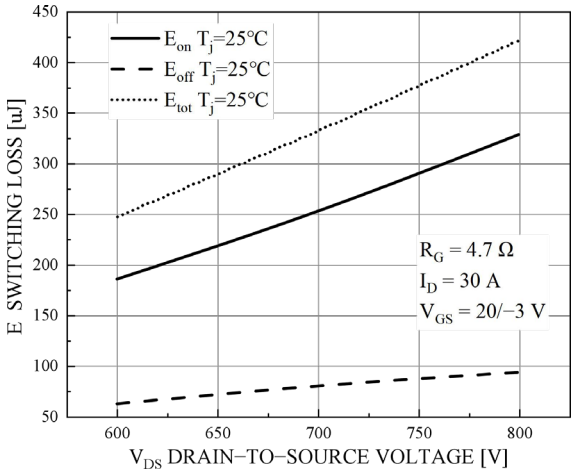



**Figure 7. Switching Loss vs. Drain−to−Source Voltage**

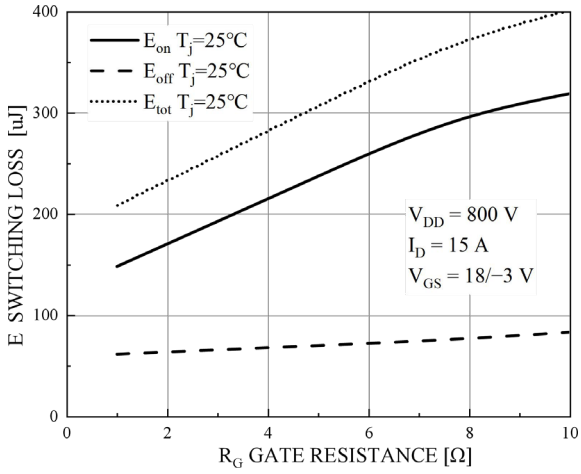



**Figure 8. Switching Loss vs. Gate Resistance**

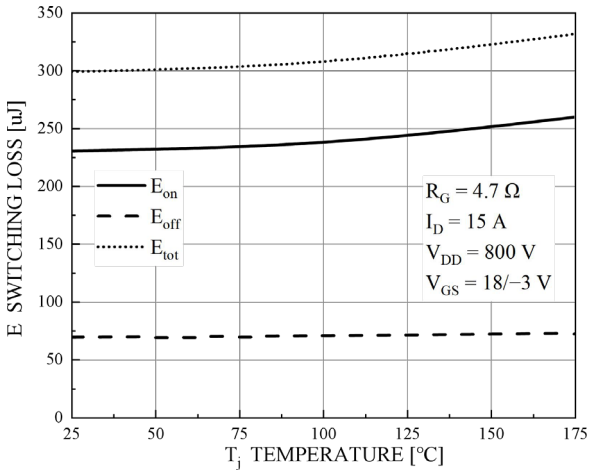



**Figure 9. Switching Loss vs. Temperature**

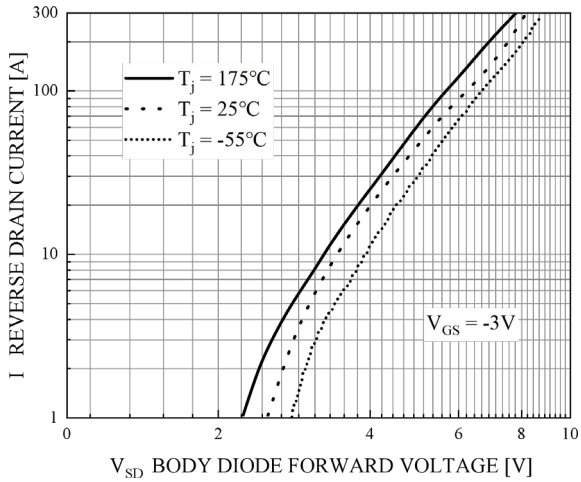



**Figure 10. Reverse Drain Current vs. Body Diode Forward Voltage**

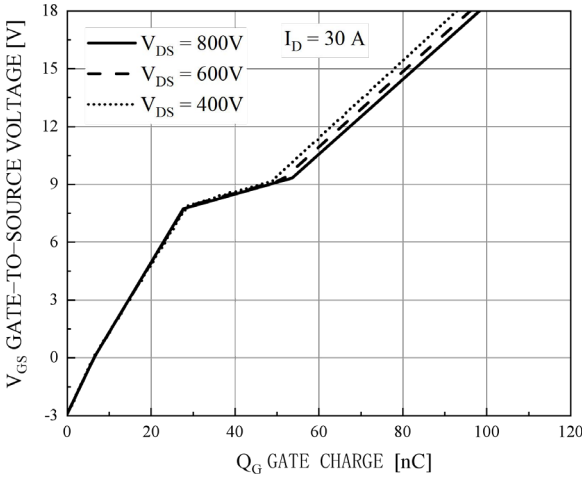



**Figure 11. Gate−to−Source Voltage vs. Total Charge**

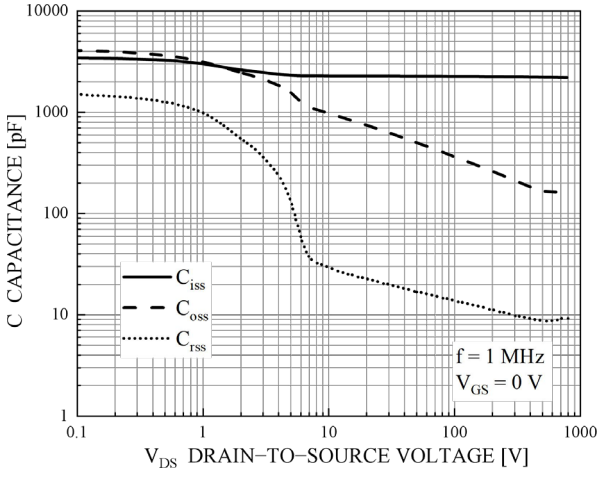



**Figure 12. Capacitance vs. Drain−to−Source Voltage**

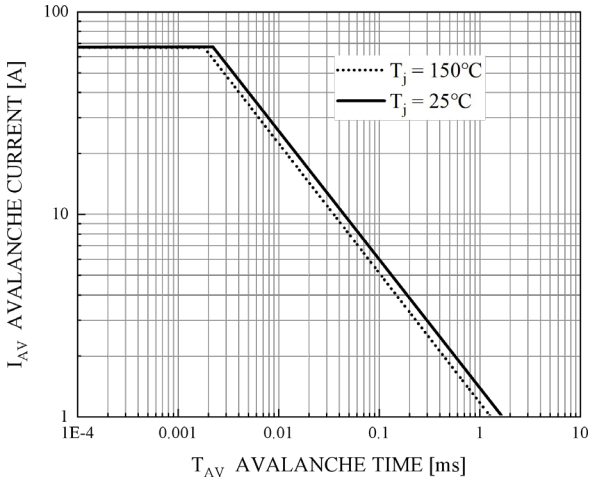



**Figure 13. Unclamped Inductive Switching Capability**

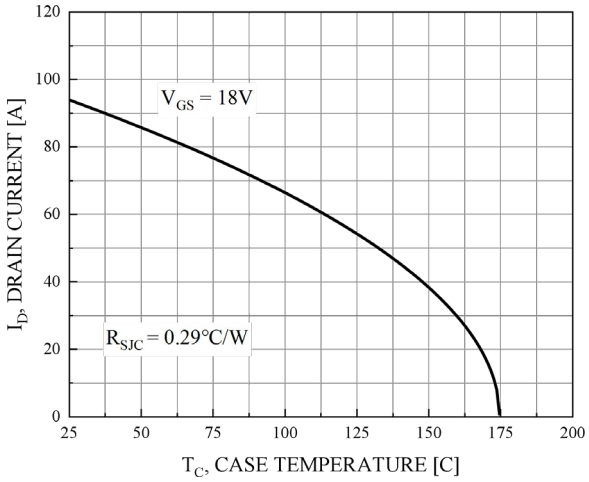



**Figure 14. Maximum Continuous Drain Current vs. Case Temperature**

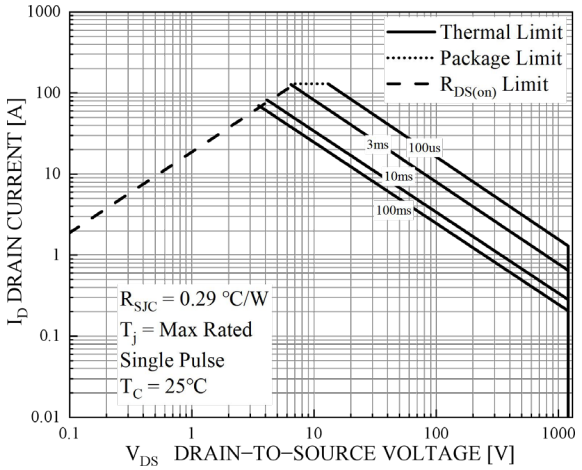



**Figure 15. Safe Operating Area**

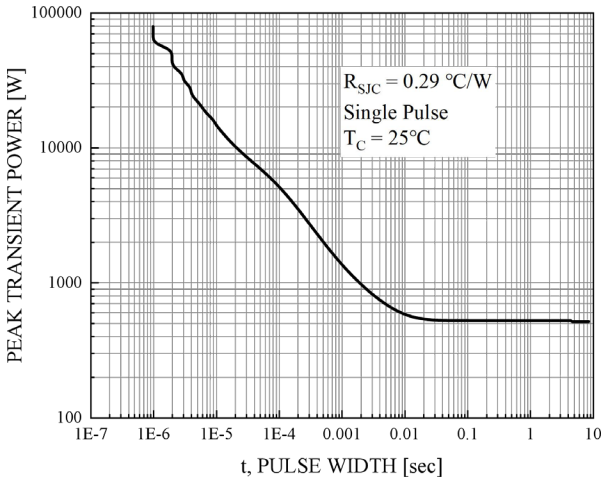



**Figure 16. Single Pulse Maximum Power Dissipation**

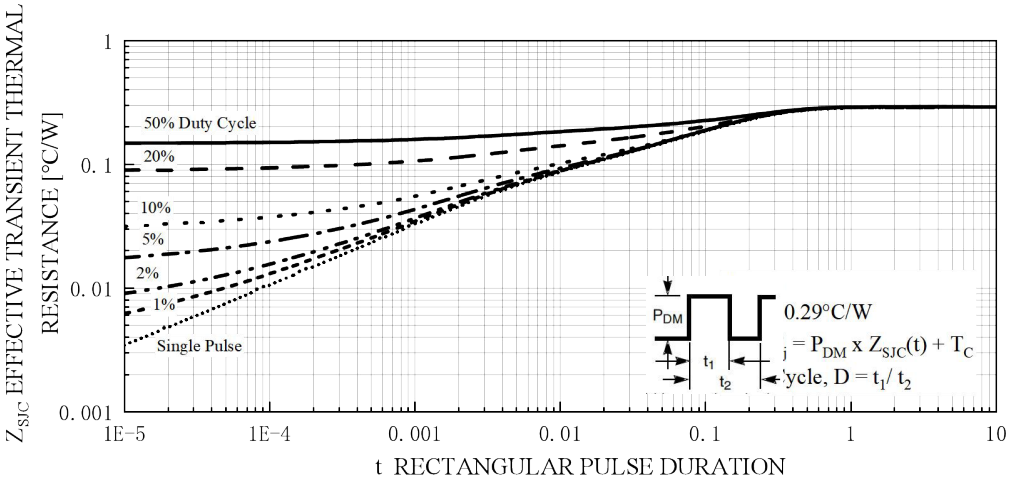
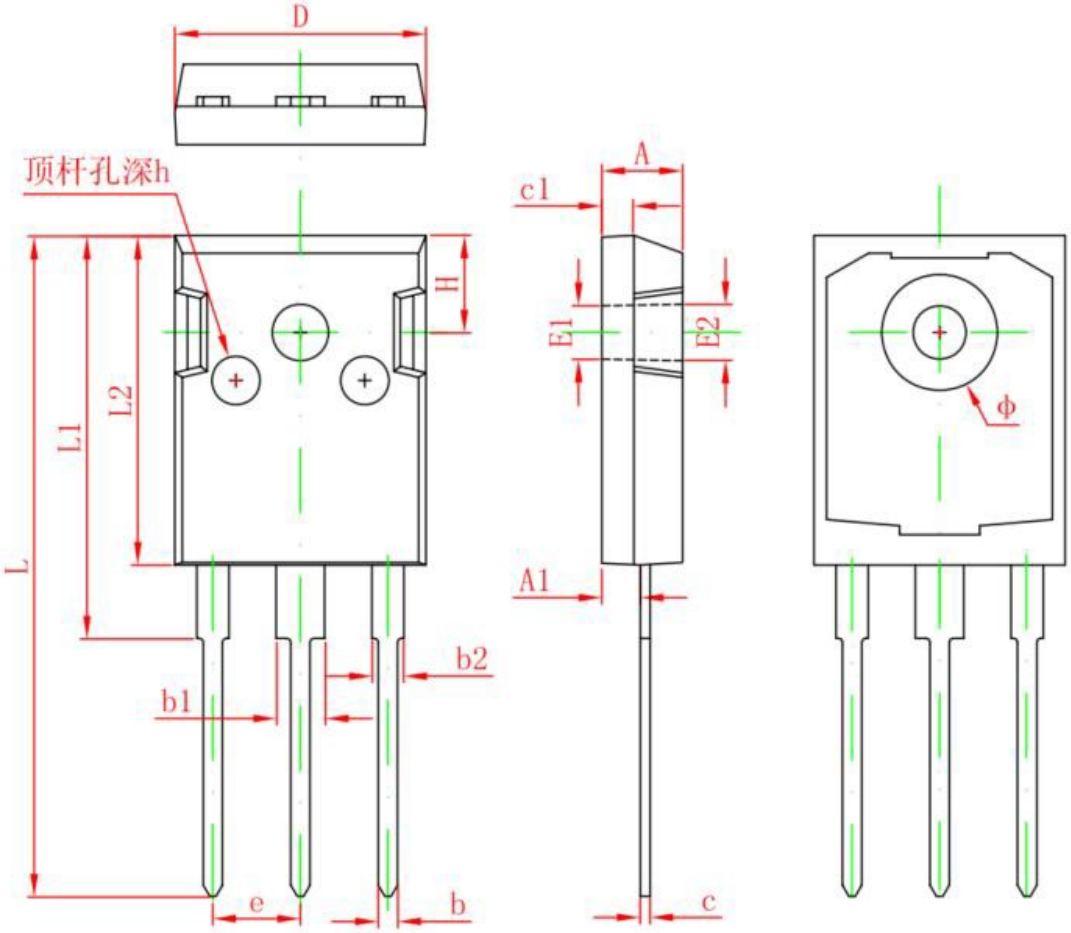



**Figure 17. Junction−to−Case Transient Thermal Response**

## TO-247-3L PACKAGE OUTLINE DIMENSIONS




| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|---|---|---|---|---|
| | Min | Max | Min | Max |
| A | 4.850 | 5.150 | 0.191 | 0.200 |
| A1 | 2.200 | 2.600 | 0.087 | 0.102 |
| b | 1.000 | 1.400 | 0.039 | 0.055 |
| b1 | 2.800 | 3.200 | 0.110 | 0.126 |
| b2 | 1.800 | 2.200 | 0.071 | 0.087 |
| c | 0.500 | 0.700 | 0.020 | 0.028 |
| c1 | 1.900 | 2.100 | 0.075 | 0.083 |
| D | 15.450 | 15.750 | 0.608 | 0.620 |
| E1 | 3.500 REF | | 0.138 REF | |
| E2 | 3.600 REF | | 0.142 REF | |
| L | 40.900 | 41.300 | 1.610 | 1.626 |
| L1 | 24.800 | 25.100 | 0.976 | 0.988 |
| L2 | 20.300 | 20.600 | 0.799 | 0.811 |
| Φ | 7.100 | 7.300 | 0.280 | 0.287 |
| e | 5.450 TYP | | 0.215 TYP | |
| H | 5.980 REF | | 0.235 REF | |
| h | 0.000 | 0.300 | 0.000 | 0.012 |